东莞东颖光电科技有限公司

DONGGUAN DONG YING OPTOELECTRONICS TECHNOLOGY CO.,LTD.

样品承认书

SPECIFICATION FOR APPROVAL

客户名 Customer 品名 Product Name 编号 Version number 规格 Dimension 材质 Texture of material 数量 Number 日期 Date 制造确认 Product confirm and sign 工程部 制作部 品质部 审核 签章 检查結果					
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Features:

- . Choice of various viewing angles
- . Available on tape and reel.
- . Reliable and robust
- . Pb free
- .The product itself will remain within RoHS compliant version.

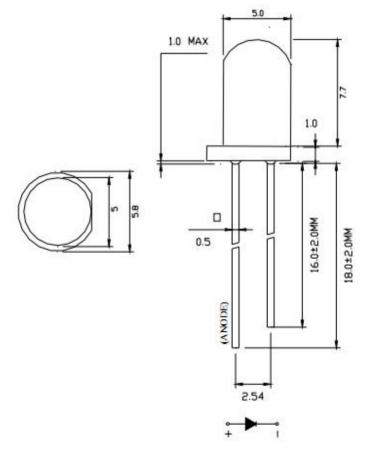
Technical Data Sheet

This product is generally used as indicator and luminary for electronic equipment such as household appliance, communication equipment, and dashboard.

Applications

- TV set
- Monitor
- Telephone
- Computer

Package Dimensions:



NOTES

1.All dimensions are in millimeters .

2.Tolerance is ±0.25mm unless otherwise noted.

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Selection Guide

Part No.	Dice	Lens Type	Luminous intensity(mcd) @ 20mA			Viewing Angle
			Min	Тур	Max	201/2
5WW4-Y-T	White (InGaN)	Water Clear	10000		12000	20

Note:

- 1.1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
- 2.the above luminous intensity measurement allowance tolerance ±15%

Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.	Тур.	Max	Units	test conditions
Forward Voltage	VF	2.8		3.6	V	IF=20mA
Reverse Current	IR			10	uA	VR = 5V
Dominate Wavelength	λd	460		465	nm	IF=20mA
Chromaticity Coordinates	x/y	0.20/0.21	0.25/0.26	0.30/0.31		IF=20mA

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Units
Power Dissipation	Pd	90	mW
DC Forward Current	IF	20	mA
Peak Forward Current [1]	IFP	60	mA
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	ESD	2000	V
Operating Temperature	Topr	-40~+80	°C
Storage Temperature	Tstg	-40~+100	°C
Lead Soldering Temperature [1.6mm(.063") From Body]		250°C for 5 seconds	

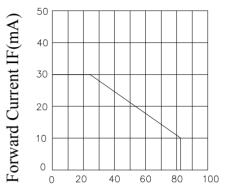
Note:

- 1. 1/10 Dut cycle,0.1ms pulse width.
- 2. The above forward voltage measure ment allowance tolerance $\pm 0.1 \text{V}$.

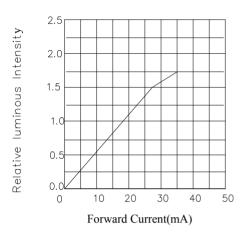
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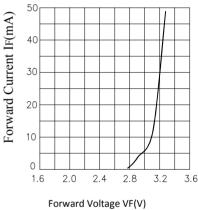
Typical optical characteristics curves

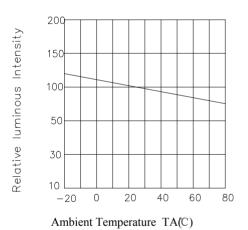
Ambient Temperature VS. Forward Current



Ambient Temperature(° C)

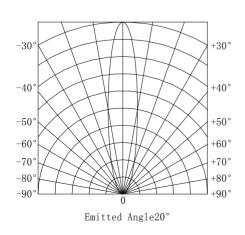






1.2 1.0 0.8 0.6 0.4 0.2 0 490 560 630 700 770 840 910 980 1050

Wavelength λ (nm)



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Reliability Test

Classification	Test Item	Test Condition	Sample	AC/Re
	Operation Life	Ta=Under Room Temperature As Per Data Sheet Maximum Rating *Test Time=1000HRS(-24HRS,+72HRS)	22	0/1
	High Temperature High Humidity Storage	Ta=85 $^{\circ}$ C RH=85% Test Time=1000HRS± 2HRS	22	0/1
Endurance Test	High Temperature High Humidity Reverse BIAS	Ta=85℃ RH=85% Test Time=500HRS(-24HRS,+48HRS)	22	0/1
	High Temperature Storage	Ta=105 \pm 5 $^{\circ}$ C *Test Time=1000HRS(-24HRS,+72HRS)	22	0/1
	Low Temperature Storage	Ta=-40 \pm 5 $^{\circ}$ C *Test Time=1000HRS(-24HRS,+72HRS)	22	0/1
Environmental Test	Temperature Cycling	105°C ~ 25°C ~ -40°C ~ 25°C 30mins 5mins 30mins 5mins $\frac{10}{10}$ Cycles	22	0/1
	Thermal Shock	105 $^{\circ}$ C±5 $^{\circ}$ C ~-40 $^{\circ}$ C±5 $^{\circ}$ C 10mins 10mins 10Cycles	22	0/1
	Solder Resistance	T.sol=260±5℃ Dwell Time=10±lsecs	22	0/1
	Solderability	T.sol=230±5℃ Dwell Time=5±lsecs	22	0/1

The appearance and specifications of the product may be modified for improvement, without prior notice.

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1.Storage time

LED can be stored for a year under the condition: the temperature of 5°C -28 $^{\circ}\text{C}$ and humility of RH60%, These production must be re-inspected and tested before use if their storage time exceed a year.

2.ESD countermeasure

Static electricity and high volt can damage LED, The production whose Die material is InGa must strictly required to prevent ESD, must put on static glove and static fillet, Soldering tool and the cover of device must connect the ground, soldering condition follows the related stating of production specification manual.

3. Soldering

When soldering leave a minimum of 2mm clearance from the base of the lens to the soldering point. Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering conditions:

Solderi	ng iron	Wave soldering		
		Pre-heat	100°C Max	
Temperature	320°C Max	Pre-heat time	60 sec.Max	
California a timo	3 sec.Max	Solder wave	250°C Max	
Soldering time	(one time only)	Soldering time	5 sec.Max	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED.

4. Drive Method

An LED is a current-operated device, In order to ensure intenity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

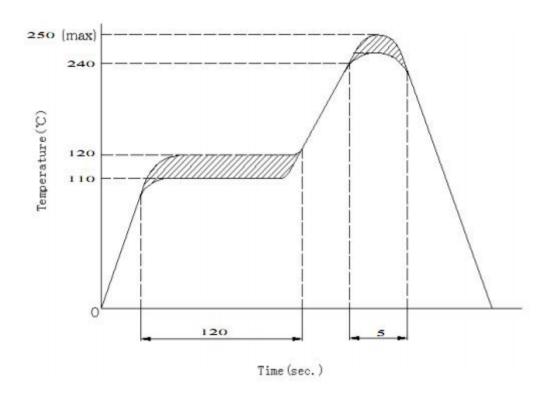


(A)Recommended circuit

(B)The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

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NOTES

■ After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.

■ A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature. DXJ

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